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| Additional name(s) of conveying party(ies) attached? No | Street Address: 416 Maetan-dong, Yeongtong-gu, City: Suwon-si, Gyeonggi-do, REPUBLIC OF KOREA |
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| If this document is being filed together with a new application, A. Patent Application No.(s) | the execution date of the application is: January 26, 2006 B. Patent No.(s) |
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ASSIGNMENT

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| | (hereinafter ASSIGNEE) all right, title and interest for the United States, its territories and possessions in and to his invention relating to |

| Title of | PIEZOELECTRIC INKIET PRINTHEAD HAVING TEMPERATURE SENSOR |
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| Invention | AND METHOD OF MAKING THE SAME |
| | as set forth in his United States Patent Application |

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Each of the undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to said ASSIGNEE, its successors or assigns in accordance herewith;

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|---------------------|---------------------------------|-----------------|----|
| Name: Young-Id HONG | Signature: Yourghi Hone | Date 26/Januar | /2 |
| Name: Tae-gyun KIM | Signature: The gyun KNN O | Date:26/January | /2 |
| Name: Jae-woo CHUNG | Signature: | Date:26/January | /2 |
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